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| TRANSMITTAL FORM (to be used for all correspondence after initial filing) | Application Number | 10/816,179 | |
| | Filing Date | March 31, 2004 | |
| | First Named Inventor | Chung J. Lee | |
| | Art Unit | 1763 | |
| | Examiner Name | | |
| Total Number of Pages in This Submission | 4+ | Attorney Docket Number | DSI 302 |

| ENCLOSURES (Check all that apply) | | |
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| <div>Remarks</div> | | |

| SIGNATURE OF APPLICANT, ATTORNEY, OR AGENT | |
|--|--|
| Firm or Individual name | M. Matthews Hall, Esq. Kolisch Hartwell, P.C. |
| Signature | <i>M. Matthews Hall</i> |
| Date | September 28, 2004 |

| CERTIFICATE OF TRANSMISSION/MAILING | |
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| Typed or printed name | Renee Knight |
| Signature | <i>Renee Knight</i> |
| Date | September 28, 2004 |

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Date: September 28, 2004

CHUNG J. LEE, ATUL KUMAR,
CHIEH CHEN and YURI PIKOVSKY

Serial No. : 10/816,179

Group Art Unit 1763

Filed : March 31, 2004

For : SYSTEM FOR FORMING COMPOSITE
POLYMER DIELECTRIC FILM

Mail Stop AMENDMENT
Commissioner for Patents
P.O. Box 1450
Alexandria, Virginia 22313-1450

Sir:

INFORMATION DISCLOSURE STATEMENT
UNDER 37 C.F.R. §§ 1.56, 1.97, and 1.98

Applicants are submitting this Information Disclosure Statement pursuant to 37 C.F.R. §§ 1.56, 1.97, and 1.98 to disclose to the U.S. Patent and Trademark Office the patents, publications, applications, and/or other references listed on the enclosed, completed PTO-1449 form(s). The filing of this Information Disclosure Statement should not be construed as a representation that a search has been made or as an admission that the listed references are prior art for this application. Applicants respectfully request that the listed references be expressly considered during prosecution of the application, and that the references be made of record therein and appear among the "references cited" on any patents issuing therefrom.

CONTENT OF DISCLOSURE

This Information Disclosure Statement includes (1) one page of PTO-1449 forms, and (2) a legible copy of each foreign and non-patent reference, if any, listed on the form(s). However, because this application was filed on or after July 1, 2003, no copies of U.S. patents or published U.S. patent applications are included.

TIMING OF DISCLOSURE / FEE INFORMATION

This Information Disclosure Statement is being filed, to the best of the undersigned's knowledge, either (1) before the mailing of a first Office action on the merits, or (2) before the mailing of a first Office action after the filing of a request for continued examination under 37 C.F.R. § 1.114. Therefore, in accordance with 37 C.F.R. § 1.97(b), no fee or statement under 37 C.F.R. § 1.97(e) is required.

Please contact the undersigned with any questions or comments regarding this Information Disclosure Statement.

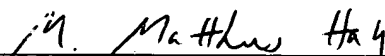
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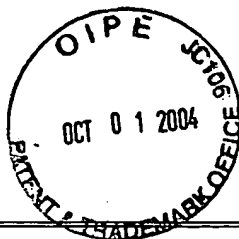
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SHEET 1 OF 1

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| FORM PTO-1449 INFORMATION DISCLOSURE CITATION IN AN APPLICATION | | DOCKET NUMBER DSI 302 | | APPLICATION NUMBER 10/816,179 | | |
| | | APPLICANTS Chung J. Lee et al. | | | | |
| | | FILING DATE March 31, 2004 | | GROUP ART UNIT 1763 | | |
| U.S. PATENT DOCUMENTS | | | | | | |
| EXAMINER INITIAL | DOCUMENT NUMBER | DATE | NAME | CLASS | SUB CLASS | FIL. DATE IF APPROP. |
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| FOREIGN PATENT DOCUMENTS | | | | | | |
| | DOCUMENT NUMBER | DATE | COUNTRY | CLASS | SUB CLASS | TRANSLATION YES NO |
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| EXAMINER | | | DATE CONSIDERED | | | |